



May 31, 2006

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Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Fr: Stephen B. Ackerman, Reg. No. 37,761
28 Davis Avenue
Poughkeepsie, N.Y. 12603

Subject:

Serial No. 10/802,563 03/17/04

Hong Yu Yu et al

“A THERMAL ROBUST SEMICONDUCTOR
DEVICE USING HFN AS METAL GATE
ELECTRODE AND THE MANUFACTURING
PROCESS THEREOF”

Grp. Art Unit: 2823

SU C. KIM

RESPONSE EX PARTE QUAYLE OFFICE ACTION

Dear Sir:

In response to the Ex parte Quayle Office Action dated May 17, 2006, please amend the
above-identified application for patent as follows:


CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal
Service as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box
1450, Alexandria, VA 22313-1450, on July 17, 2006.

Stephen B. Ackerman, Reg. No. 37,761

Signature

Date


7/14/06

Amendments to the Drawings begin on page 3 of this paper and include an attached replacement sheet.

Remarks/Arguments begin on page 4 of this paper.

An Appendix including amended drawing figures is attached following page 4 of this paper.